



# Product Change Notification

**Change Notification #:** 115464 - 01  
**Change Title:** Intel® Server Chassis H2216XXKR2, H2216XXLR2, H2224XXKR2, H2224XXLR2, H2312XXKR2, H2312XXLR2, PCN 115464-01, Product Material, Label, Removal of QRL  
**Reason for Revision:** Correct the URL to download the QRL in digital format  
**Date of Publication:** May 08, 2017

## Key Characteristics of the Change:

Product Material, Label

## Forecasted Key Milestones:

<b>Date Customer Must be Ready to Receive Post-Conversion Material: *</b>	May 04, 2017
---	--------------

*\* Intel appreciates the customer's desire to receive the latest revision of products. However, Intel manages inventory on a first in first out (FIFO) basis at the MM# level. Subsequently, customer requests for a specific revision of material (below the MM#) will not be supported by Intel.*

**Reason for Revision:** Corrected the URL to download the QRL in digital format

## Description of Change to the Customer:

Intel is removing the chassis-only Quick Reference Label (QRL) H70975-002 due to its limited visibility while servicing the chassis from the back of the rack (hot-aisle).

Intel has made available the QRL in digital format for download at <http://www.intel.com/content/www/us/en/support/server-products/000006134.html>

Please refer to the Products Affected table below for a summary of TA changes.

Figure 1. Chassis-only QRL to be removed

## Quick Reference IMPORTANT NOTE: Please read all Warnings/Cautions before servicing this product!

### Front Panel Feature Identification

**3.5" Drive Identification - 12 Drive Configuration**

**2.5" Drive Identification - 16 Drive Configuration**

**2.5" Drive Identification - 24 Drive Configuration**

Note: Please refer to the technical product specification for compatible compute module.

### Back Panel Feature Identification

Network Link/Activity LED  
Power Button with LED  
Status LED  
ID Button with LED

#### Protective Cap Removal

**CAUTION** Remove the protective cap from the bridge board before inserting the compute module into the chassis.

#### Power Supply Installation

**A** Align and slide the power supply into the power cage.

**B** While pressing the latch, push the power supply along the power cage rail until the latch locks in position.

**WARNING** Allow system components to cool before touching.

**CAUTION** Systems can weigh up to 92lbs (42kg). It is highly recommended to have two people when lifting the system.

**Warning!** The power distribution module cover must be in place when system is powered ON.

**CAUTION** Observe normal ESD (Electrostatic Discharge) procedures during system integration to avoid possible damage to server board and/or other components.

**CAUTION** Danger of explosion if battery is replaced incorrectly. The lithium battery in the real-time clock must be replaced with the same or equivalent type part. Contact your service representative to obtain a qualified replacement part. Dispose of used parts in accordance with local regulations. **DO NOT** dispose of in fire.

H70975-002

↑ RED DOTTED LINES AND CROP MARKS DO NOT PRINT! ↓

## Customer Impact of Change and Recommended Action:

Intel does not expect any impact to customers from these changes, but encourages customers to understand the change and determine the impact on their applications.

## Products Affected / Intel Ordering Codes:

Product Code	MM#	Pre Change TA	Post Change TA
H2216XXKR2	933688	H20866-010	H20866-011
H2312XXKR2	933689	H20865-010	H20865-011
H2312XXLR2	942352	J17277-003	J17277-004
H2216XXLR2	942353	H95607-003	H95607-004
H2224XXKR2	943478	H70096-007	H70096-008
H2224XXLR2	943577	H96144-002	H96144-003

## PCN Revision History:

**Date of Revision:**

April 20, 2017

[May 08, 2017](#)

**Revision Number:**

00

[01](#)

**Reason:**

Originally Published PCN

[Corrected the URL to download the QRL in digital format](#)



# Product Change Notification

## 115464 - 01

**INFORMATION IN THIS DOCUMENT IS PROVIDED IN CONNECTION WITH INTEL PRODUCTS. NO LICENSE, EXPRESS OR IMPLIED, BY ESTOPPEL OR OTHERWISE, TO ANY INTELLECTUAL PROPERTY RIGHTS IS GRANTED BY THIS DOCUMENT. EXCEPT AS PROVIDED IN INTEL'S TERMS AND CONDITIONS OF SALE FOR SUCH PRODUCTS, INTEL ASSUMES NO LIABILITY WHATSOEVER AND INTEL DISCLAIMS ANY EXPRESS OR IMPLIED WARRANTY, RELATING TO SALE AND/OR USE OF INTEL PRODUCTS INCLUDING LIABILITY OR WARRANTIES RELATING TO FITNESS FOR A PARTICULAR PURPOSE, MERCHANTABILITY, OR INFRINGEMENT OF ANY PATENT, COPYRIGHT OR OTHER INTELLECTUAL PROPERTY RIGHT.**

A "Mission Critical Application" is any application in which failure of the Intel Product could result, directly or indirectly, in personal injury or death. SHOULD YOU PURCHASE OR USE INTEL'S PRODUCTS FOR ANY SUCH MISSION CRITICAL APPLICATION, YOU SHALL INDEMNIFY AND HOLD INTEL AND ITS SUBSIDIARIES, SUBCONTRACTORS AND AFFILIATES, AND THE DIRECTORS, OFFICERS, AND EMPLOYEES OF EACH, HARMLESS AGAINST ALL CLAIMS COSTS, DAMAGES, AND EXPENSES AND REASONABLE ATTORNEYS' FEES ARISING OUT OF, DIRECTLY OR INDIRECTLY, ANY CLAIM OF PRODUCT LIABILITY, PERSONAL INJURY, OR DEATH ARISING IN ANY WAY OUT OF SUCH MISSION CRITICAL APPLICATION, WHETHER OR NOT INTEL OR ITS SUBCONTRACTOR WAS NEGLIGENT IN THE DESIGN, MANUFACTURE, OR WARNING OF THE INTEL PRODUCT OR ANY OF ITS PARTS.

Intel may make changes to specifications and product descriptions at any time, without notice. Designers must not rely on the absence or characteristics of any features or instructions marked "reserved" or "undefined". Intel reserves these for future definition and shall have no responsibility whatsoever for conflicts or incompatibilities arising from future changes to them. The information here is subject to change without notice. Do not finalize a design with this information.

The products described in this document may contain design defects or errors known as errata which may cause the product to deviate from published specifications. Current characterized errata are available on request.

**Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.**

**Americas Contact:** [asmo.pcn@intel.com](mailto:asmo.pcn@intel.com)

**Asia Pacific/PRC Contact:** [apacgccb@intel.com](mailto:apacgccb@intel.com)

**Europe Email:** [eccb@intel.com](mailto:eccb@intel.com)

**Japan Email:** [jccb.ijkk@intel.com](mailto:jccb.ijkk@intel.com)

Copyright © Intel Corporation 2017. Other names and brands may be claimed as the property of others.

BunnyPeople, Celeron, Celeron Inside, Centrino, Centrino Inside, Cilk, Core Inside, i960, Intel, the Intel logo, Intel AppUp, Intel Atom, Intel Atom Inside, Intel Core, Intel Inside, Intel Insider, the Intel Inside logo, Intel NetBurst, Intel NetMerge, Intel NetStructure, Intel SingleDriver, Intel SpeedStep, Intel Sponsors of Tomorrow, the Intel Sponsors of Tomorrow logo, Intel StrataFlash, Intel vPro, Intel XScale, InTru, the InTru logo, the InTru Inside logo, InTru soundmark, Itanium, Itanium Inside, MCS, MMX, Moblin, Pentium, Pentium Inside, Puma, skool, the skool logo, Sound Mark, The Creators Project, The Journey Inside, Thunderbolt, vPro Inside, VTune, Xeon, and Xeon Inside are trademarks of Intel Corporation in the U.S. and/or other countries.

Learn how to use Intel Trademarks and Brands correctly at <http://www.intel.com/intel/legal/tmusage2.htm>.